Ĺ	Hits	Search Text	DB	Time stamp
Number	1			
1	0	"09806099"	USPAT;	2003/12/09
			EPO; JPO;	12:39
			DERWENT]
2	0	"09806099"	USPAT;	2003/12/09
			US-PGPUB;	12:39
			EPO; JPO;	
		,	DERWENT	
3	6	("9806099").PN.	USPAT;	2003/12/09
			EPO; JPO;	12:39
			DERWENT	
4	1179	(15/77,102,88.1,88.221.1).CCLS.	USPAT;	2003/12/09
			EPO; JPO;	12:58
			DERWENT	
5	204	((15/77,102,88.1,88.221.1).CCLS.) and	USPAT;	2003/12/09
		(wafer or semiconductor)	EPO; JPO;	12:58
			DERWENT	
6	2777	(134/902,144,153,95.3).CCLS.	USPAT;	2003/12/09
			EPO; JPO;	12:58
			DERWENT	
7	1582	((134/902,144,153,95.3).CCLS.) and (wafer	USPAT;	2003/12/09
		or semiconductor)	EPO; JPO;	12:59
_			DERWENT	
8	2771	H01L021/68.ipc. and (tokyo adj electron)	USPAT;	2003/12/09
			EPO; JPO;	12:59
_			DERWENT	1
9	1642		USPAT;	2003/12/09
		electron)) and wafer	EPO; JPO;	12:59
			DERWENT	
10	8	((H01L021/68.ipc. and (tokyo adj	USPAT;	2003/12/09
		electron)) and wafer) and brush	EPO; JPO;	12:59
			DERWENT	